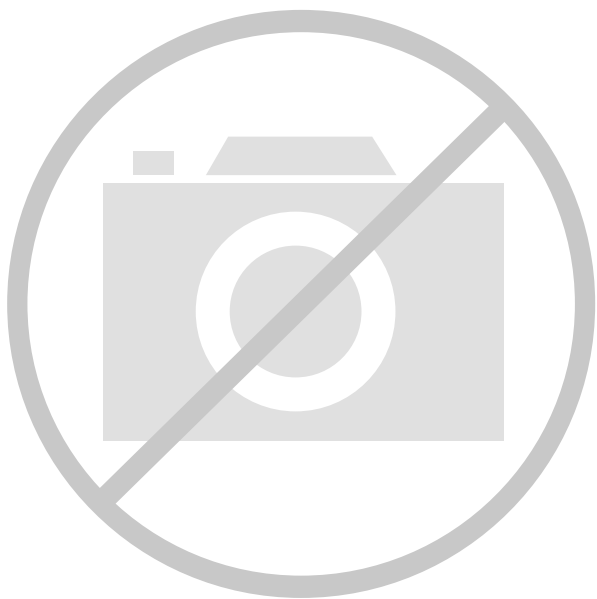




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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	128
Number of Logic Elements/Cells	-
Total RAM Bits	147456
Number of I/O	92
Number of Gates	80000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	144-TFBGA, CSPBGA
Supplier Device Package	144-LCSBGA (12x12)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2v80-5csg144c

Figure 18, Figure 19, and Figure 20 illustrate various example configurations.

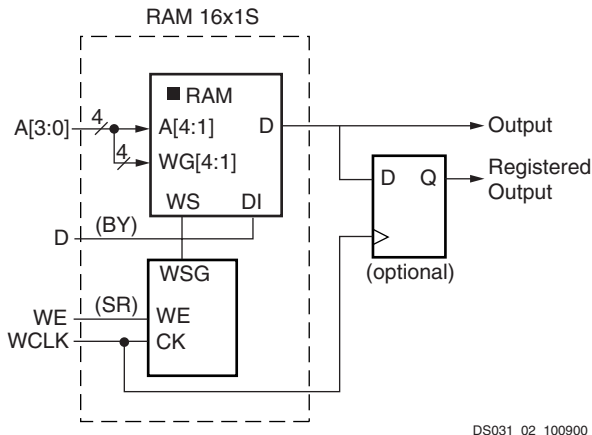


Figure 18: Distributed SelectRAM (RAM16x1S)

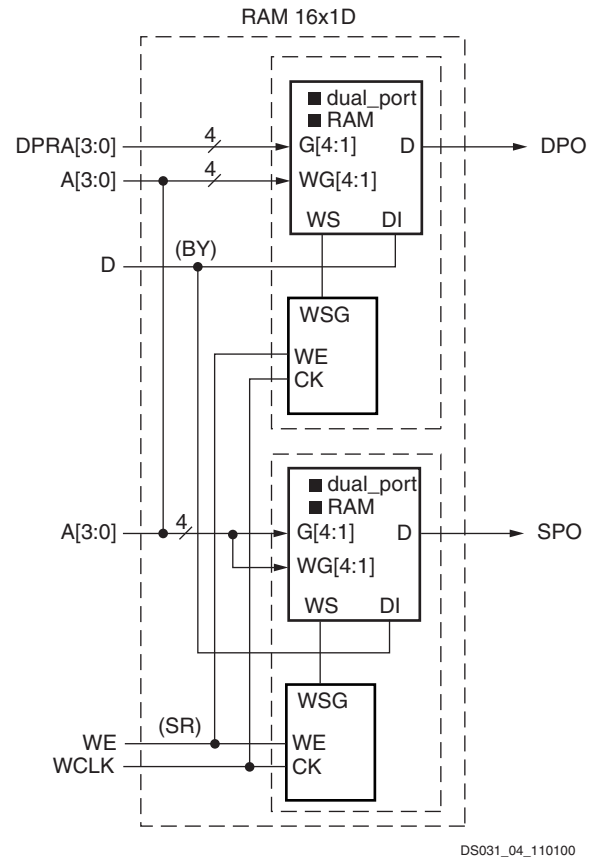


Figure 20: Dual-Port Distributed SelectRAM (RAM16x1D)

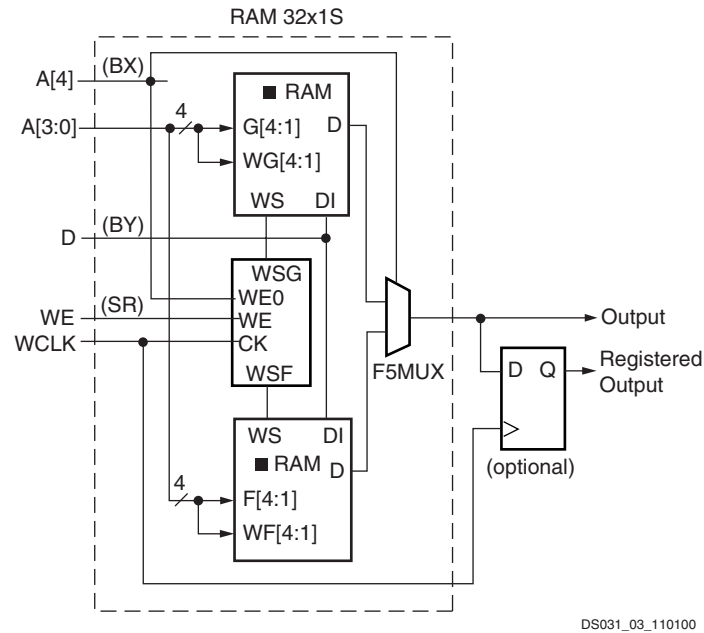


Figure 19: Single-Port Distributed SelectRAM (RAM32x1S)

Similar to the RAM configuration, each function generator (LUT) can implement a 16 x 1-bit ROM. Five configurations are available: ROM16x1, ROM32x1, ROM64x1, ROM128x1, and ROM256x1. The ROM elements are cascadable to implement wider or/and deeper ROM. ROM contents are loaded at configuration. Table 10 shows the number of LUTs occupied by each configuration.

Table 10: ROM Configuration

ROM	Number of LUTs
16 x 1	1
32 x 1	2
64 x 1	4
128 x 1	8 (1 CLB)
256 x 1	16 (2 CLBs)

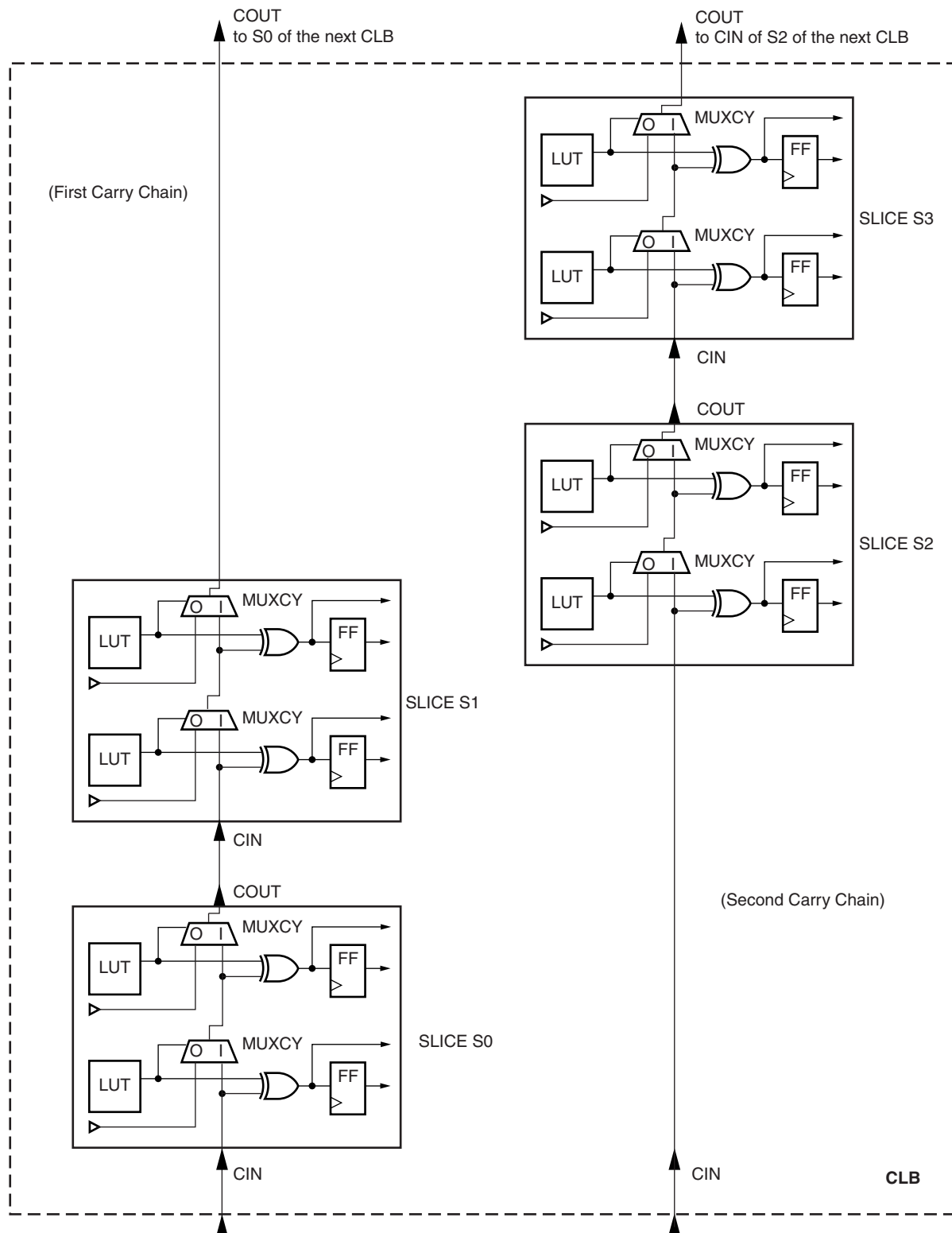


Figure 24: Fast Carry Logic Path

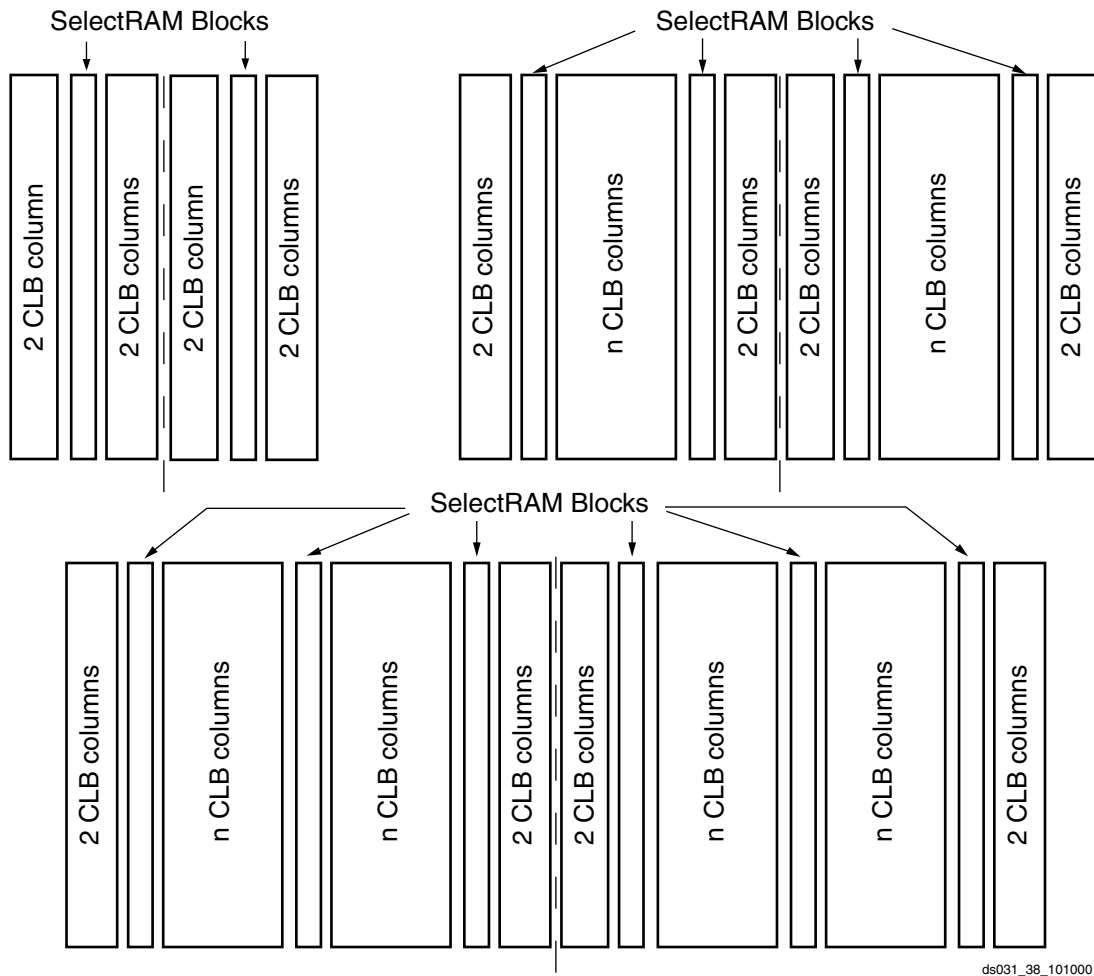


Figure 34: Block SelectRAM (2-column, 4-column, and 6-column)

Total Amount of SelectRAM Memory

Table 19 shows the amount of block SelectRAM memory available for each Virtex-II device. The 18 Kbit SelectRAM blocks are cascadable to implement deeper or wider single- or dual-port memory resources.

Table 19: Virtex-II SelectRAM Memory Available

Device	Total SelectRAM Memory		
	Blocks	in Kbits	in Bits
XC2V40	4	72	73,728
XC2V80	8	144	147,456
XC2V250	24	432	442,368
XC2V500	32	576	589,824
XC2V1000	40	720	737,280
XC2V1500	48	864	884,736
XC2V2000	56	1,008	1,032,192

Table 19: Virtex-II SelectRAM Memory Available

Device	Total SelectRAM Memory		
	Blocks	in Kbits	in Bits
XC2V3000	96	1,728	1,769,472
XC2V4000	120	2,160	2,211,840
XC2V6000	144	2,592	2,654,208
XC2V8000	168	3,024	3,096,576

18-Bit x 18-Bit Multipliers

Introduction

A Virtex-II multiplier block is an 18-bit by 18-bit 2's complement signed multiplier. Virtex-II devices incorporate many embedded multiplier blocks. These multipliers can be associated with an 18 Kbit block SelectRAM resource or can be used independently. They are optimized for high-speed operations and have a lower power consumption compared to an 18-bit x 18-bit multiplier in slices.

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Virtex-II Data Sheet

The Virtex-II Data Sheet contains the following modules:

- [Virtex-II Platform FPGAs: Introduction and Overview \(Module 1\)](#)
- [Virtex-II Platform FPGAs: Functional Description \(Module 2\)](#)
- [Virtex-II Platform FPGAs: DC and Switching Characteristics \(Module 3\)](#)
- [Virtex-II Platform FPGAs: Pinout Information \(Module 4\)](#)

Table 12: Register-to-Register Performance (Continued)

Description	Device Used & Speed Grade	Register-to-Register Performance	Units
8-bit Adder	XC2V1000 -5	292	MHz
16-bit Adder	XC2V1000 -5	239	MHz
64-bit Adder	XC2V1000 -5	114	MHz
64-bit Counter	XC2V1000 -5	114	MHz
64-bit Accumulator	XC2V1000 -5	110	MHz
Multiplier 18x18 (with Block RAM inputs)	XC2V1000 -5	88	MHz
Multiplier 18x18 (with Register inputs)	XC2V1000 -5	105	MHz
Memory			
Block RAM			
Single-Port 4096 x 4 bits		278	MHz
Single-Port 2048 x 9 bits		277	MHz
Single-Port 1024 x 18 bits		270	MHz
Single-Port 512 x 36 bits		253	MHz
Dual-Port A:4096 x 4 bits & B:1024 x 18 bits		257	MHz
Dual-Port A:1024 x 18 bits & B:1024 x 18 bits		259	MHz
Dual-Port A:2048 x 9 bits & B: 512 x 36 bits		250	MHz
Distributed RAM			
Single-Port 32 x 8-bit	XC2V1000 -5	387	MHz
Single-Port 64 x 8-bit	XC2V1000 -5	335	MHz
Single-Port 128 x 8-bit	XC2V1000 -5	266	MHz
Dual-Port 16 x 8	XC2V1000 -5	409	MHz
Dual-Port 32 x 8	XC2V1000 -5	311	MHz
Dual-Port 64 x 8	XC2V1000 -5	294	MHz
Shift Registers			
128-bit SRL		N/A	MHz
256-bit SRL		N/A	MHz
FIFOs (Async. in Block RAM)			
1024 x 18-bit Read		279	MHz
1024 x 18-bit Write		172	MHz
FIFOs (Sync. in SRL)			
128 x 8-bit		N/A	MHz
128 x 16-bit		N/A	MHz

Block SelectRAM Switching Characteristics

Table 28: Block SelectRAM Switching Characteristics

Description	Symbol	Speed Grade			Units
		-6	-5	-4	
Sequential Delays					
Clock CLK to DOUT output	T _{BCKO}	2.10	2.31	2.65	ns, Max
Setup and Hold Times Before Clock CLK					
ADDR inputs	T _{BACK} /T _{BCKA}	0.29/ 0.00	0.32/ 0.00	0.36/ 0.00	ns, Min
DIN inputs	T _{BDCK} /T _{BCKD}	0.29/ 0.00	0.32/ 0.00	0.36/ 0.00	ns, Min
EN input	T _{BECK} /T _{BCKE}	0.95/−0.46	1.04/−0.50	1.20/−0.58	ns, Min
RST input	T _{BRCK} /T _{BCKR}	1.31/−0.71	1.44/−0.78	1.65/−0.90	ns, Min
WEN input	T _{BWCK} /T _{BCKW}	0.57/−0.19	0.63/−0.21	0.72/−0.25	ns, Min
Clock CLK					
CLKA to CLKB setup time for different ports	T _{BCCS}	1.0	1.0	1.0	ns, min
Minimum Pulse Width, High	T _{BPWH}	1.17	1.29	1.48	ns, Min
Minimum Pulse Width, Low	T _{BPWL}	1.17	1.29	1.48	ns, Min

TBUF Switching Characteristics

Table 29: TBUF Switching Characteristics

Description	Symbol	Speed Grade			Units
		-6	-5	-4	
Combinatorial Delays					
IN input to OUT output	T _{IO}	0.45	0.50	0.58	ns, Max
TRI input to OUT output high-impedance	T _{OFF}	0.44	0.48	0.55	ns, Max
TRI input to valid data on OUT output	T _{ON}	0.44	0.48	0.55	ns, Max

Source-Synchronous Switching Characteristics

The parameters in this section provide the necessary values for calculating timing budgets for Virtex-II source-synchronous transmitter and receiver data-valid windows.

Table 45: Duty Cycle Distortion and Clock-Tree Skew

Description	Symbol	Device	Speed Grade			Units
			-6	-5	-4	
Duty Cycle Distortion ⁽¹⁾	T_{DCD_CLK0}	All	140	140	140	ps
	T_{DCD_CLK180}	All	50	50	50	ps
Clock Tree Skew ⁽²⁾	T_{CKSKEW}	XC2V40	50	50	60	ps
		XC2V80	50	50	60	ps
		XC2V250	50	50	60	ps
		XC2V500	50	50	60	ps
		XC2V1000	80	80	90	ps
		XC2V1500	80	80	90	ps
		XC2V2000	100	100	110	ps
		XC2V3000	100	100	110	ps
		XC2V4000	400	400	450	ps
		XC2V6000	500	500	550	ps
		XC2V8000		600	650	ps

Notes:

- These parameters represent the worst-case duty cycle distortion observable at the pins of the device using LVDS output buffers. For cases where other I/O standards are used, IBIS can be used to calculate any additional duty cycle distortion that might be caused by asymmetrical rise/fall times.
 T_{DCD_CLK0} applies to cases where local (IOB) inversion is used to provide the negative-edge clock to the DDR element in the I/O.
 T_{DCD_CLK180} applies to cases where the CLK180 output of the DCM is used to provide the negative-edge clock to the DDR element in the I/O.
- This value represents the worst-case clock-tree skew observable between sequential I/O elements. Significantly less clock-tree skew exists for I/O registers that are close to each other and fed by the same or adjacent clock-tree branches. Use the Xilinx FPGA_Editor and Timing Analyzer tools to evaluate clock skew specific to your application.

Table 46: Package Skew

Description	Symbol	Device/Package	Value	Units
Package Skew ⁽¹⁾	$T_{PKGSKEW}$	XC2V1000 / FF896	130	ps
		XC2V3000 / FF1152	115	ps
		XC2V3000 / BF957	130	ps
		XC2V4000 / FF1152	130	ps
		XC2V4000 / FF1517	200	ps
		XC2V4000 / BF957	140	ps
		XC2V6000 / FF1152	90	ps
		XC2V6000 / FF1517	105	ps
		XC2V6000 / BF957	105	ps

Notes:

- These values represent the worst-case skew between any two balls of the package: shortest flight time to longest flight time from Pad to Ball (7.1ps per mm).
- Package trace length information is available for these device/package combinations. This information can be used to deskew the package.

Table 6: FG256/FGG256 BGA — XC2V40, XC2V80, XC2V250, XC2V500, and XC2V1000

Bank	Pin Description	Pin Number	No Connect in XC2V40	No Connect in XC2V80
4	IO_L91N_4/VREF_4	R11	NC	NC
4	IO_L91P_4	T11	NC	NC
4	IO_L92N_4	M11	NC	NC
4	IO_L92P_4	M10	NC	NC
4	IO_L93N_4	N10	NC	NC
4	IO_L93P_4	P10	NC	NC
4	IO_L94N_4/VREF_4	R10		
4	IO_L94P_4	T10		
4	IO_L95N_4/GCLK3S	N9		
4	IO_L95P_4/GCLK2P	P9		
4	IO_L96N_4/GCLK1S	R9		
4	IO_L96P_4/GCLK0P	T9		
5	IO_L96N_5/GCLK7S	T8		
5	IO_L96P_5/GCLK6P	R8		
5	IO_L95N_5/GCLK5S	P8		
5	IO_L95P_5/GCLK4P	N8		
5	IO_L94N_5	T7		
5	IO_L94P_5/VREF_5	R7		
5	IO_L93N_5	P7	NC	NC
5	IO_L93P_5	N7	NC	NC
5	IO_L92N_5	M7	NC	NC
5	IO_L92P_5	M6	NC	NC
5	IO_L91N_5	T6	NC	NC
5	IO_L91P_5/VREF_5	R6	NC	NC
5	IO_L05N_5/VRP_5	P6	NC	NC
5	IO_L05P_5/VRN_5	N6	NC	NC
5	IO_L04N_5	T5	NC	NC
5	IO_L04P_5/VREF_5	R5	NC	NC
5	IO_L03N_5/D4/ALT_VRP_5	P5		
5	IO_L03P_5/D5/ALT_VRN_5	N5		
5	IO_L02N_5/D6	R4		
5	IO_L02P_5/D7	P4		
5	IO_L01N_5/RDWR_B	T4		

Table 6: FG256/FGG256 BGA — XC2V40, XC2V80, XC2V250, XC2V500, and XC2V1000

Bank	Pin Description	Pin Number	No Connect in XC2V40	No Connect in XC2V80
7	IO_L45N_7	F5	NC	NC
7	IO_L43P_7	F1	NC	NC
7	IO_L43N_7	F2	NC	NC
7	IO_L06P_7	F3	NC	
7	IO_L06N_7	F4	NC	
7	IO_L04P_7	E1	NC	
7	IO_L04N_7	E2	NC	
7	IO_L03P_7/VREF_7	E3		
7	IO_L03N_7	E4		
7	IO_L02P_7/VRN_7	D2		
7	IO_L02N_7/VRP_7	D3		
7	IO_L01P_7	D1		
7	IO_L01N_7	C1		
0	VCCO_0	F8		
0	VCCO_0	F7		
0	VCCO_0	E8		
1	VCCO_1	F10		
1	VCCO_1	F9		
1	VCCO_1	E9		
2	VCCO_2	H12		
2	VCCO_2	H11		
2	VCCO_2	G11		
3	VCCO_3	K11		
3	VCCO_3	J12		
3	VCCO_3	J11		
4	VCCO_4	M9		
4	VCCO_4	L10		
4	VCCO_4	L9		
5	VCCO_5	M8		
5	VCCO_5	L8		
5	VCCO_5	L7		
6	VCCO_6	K6		
6	VCCO_6	J6		

Table 7: FG456/FGG456 BGA — XC2V250, XC2V500, and XC2V1000

Bank	Pin Description	Pin Number	No Connect in XC2V250	No Connect in XC2V500
1	IO_L21P_1	D16	NC	NC
1	IO_L06N_1	E16		
1	IO_L06P_1	E17		
1	IO_L05N_1	A17		
1	IO_L05P_1	B17		
1	IO_L04N_1	C17		
1	IO_L04P_1/VREF_1	D17		
1	IO_L03N_1/VRP_1	A18		
1	IO_L03P_1/VRN_1	B18		
1	IO_L02N_1	C18		
1	IO_L02P_1	D18		
1	IO_L01N_1	A19		
1	IO_L01P_1	B19		
2	IO_L01N_2	C21		
2	IO_L01P_2	C22		
2	IO_L02N_2/VRP_2	E18		
2	IO_L02P_2/VRN_2	F18		
2	IO_L03N_2	D21		
2	IO_L03P_2/VREF_2	D22		
2	IO_L04N_2	E19		
2	IO_L04P_2	E20		
2	IO_L06N_2	E21		
2	IO_L06P_2	E22		
2	IO_L19N_2	F19	NC	NC
2	IO_L19P_2	F20	NC	NC
2	IO_L21N_2	F21	NC	NC
2	IO_L21P_2/VREF_2	F22	NC	NC
2	IO_L22N_2	G18	NC	NC
2	IO_L22P_2	H18	NC	NC
2	IO_L24N_2	G19	NC	NC
2	IO_L24P_2	G20	NC	NC
2	IO_L43N_2	G21		
2	IO_L43P_2	G22		

Table 7: FG456/FGG456 BGA — XC2V250, XC2V500, and XC2V1000

Bank	Pin Description	Pin Number	No Connect in XC2V250	No Connect in XC2V500
NA	GND	M10		
NA	GND	M9		
NA	GND	L14		
NA	GND	L13		
NA	GND	L12		
NA	GND	L11		
NA	GND	L10		
NA	GND	L9		
NA	GND	K14		
NA	GND	K13		
NA	GND	K12		
NA	GND	K11		
NA	GND	K10		
NA	GND	K9		
NA	GND	J14		
NA	GND	J13		
NA	GND	J12		
NA	GND	J11		
NA	GND	J10		
NA	GND	J9		
NA	GND	D19		
NA	GND	D4		
NA	GND	C20		
NA	GND	C3		
NA	GND	B21		
NA	GND	B2		
NA	GND	A22		
NA	GND	A1		

Notes:

1. See Table 4 for an explanation of the signals available on this pin.

Table 9: BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in XC2V1000	No Connect in XC2V1500
7	IO_L46P_7	H2		
7	IO_L46N_7	G2		
7	IO_L45P_7/VREF_7	H3		
7	IO_L45N_7	H4		
7	IO_L43P_7	G3		
7	IO_L43N_7	G4		
7	IO_L24P_7	H5		
7	IO_L24N_7	H6		
7	IO_L22P_7	J6		
7	IO_L22N_7	J7		
7	IO_L21P_7/VREF_7	K7		
7	IO_L21N_7	K8		
7	IO_L19P_7	E1		
7	IO_L19N_7	E2		
7	IO_L06P_7	D2		
7	IO_L06N_7	D3		
7	IO_L04P_7	E3		
7	IO_L04N_7	E4		
7	IO_L03P_7/VREF_7	F4		
7	IO_L03N_7	F5		
7	IO_L02P_7/VRN_7	G5		
7	IO_L02N_7/VRP_7	G6		
7	IO_L01P_7	H7		
7	IO_L01N_7	J8		
0	VCCO_0	J12		
0	VCCO_0	J11		
0	VCCO_0	J10		
0	VCCO_0	F11		
0	VCCO_0	C6		
0	VCCO_0	B11		
1	VCCO_1	J15		
1	VCCO_1	J14		
1	VCCO_1	J13		
1	VCCO_1	F14		
1	VCCO_1	C19		

Table 10: BG728 BGA — XC2V3000

Bank	Pin Description	Pin Number
3	IO_L19N_3	AB26
3	IO_L19P_3	AB25
3	IO_L06N_3	AB24
3	IO_L06P_3	AB23
3	IO_L04N_3	AC27
3	IO_L04P_3	AC26
3	IO_L03N_3/VREF_3	AC25
3	IO_L03P_3	AC24
3	IO_L02N_3/VRP_3	AD27
3	IO_L02P_3/VRN_3	AE27
3	IO_L01N_3	AD26
3	IO_L01P_3	AD25
4	IO_L01N_4/BUSY/DOOUT ⁽¹⁾	AF25
4	IO_L01P_4/INIT_B	AG25
4	IO_L02N_4/D0/DIN ⁽¹⁾	AF24
4	IO_L02P_4/D1	AG24
4	IO_L03N_4/D2/ALT_VRP_4	AD23
4	IO_L03P_4/D3/ALT_VRN_4	AE23
4	IO_L04N_4/VREF_4	AF23
4	IO_L04P_4	AG23
4	IO_L05N_4/VRP_4	AD22
4	IO_L05P_4/VRN_4	AE22
4	IO_L06N_4	AF22
4	IO_L06P_4	AG22
4	IO_L19N_4	AC21
4	IO_L19P_4	AB21
4	IO_L21N_4	AE21
4	IO_L21P_4/VREF_4	AE20
4	IO_L22N_4	AF21
4	IO_L22P_4	AG21
4	IO_L24N_4	AB20
4	IO_L24P_4	AA20
4	IO_L25N_4	AC20
4	IO_L25P_4	AD20
4	IO_L27N_4	AG20

Table 10: BG728 BGA — XC2V3000

Bank	Pin Description	Pin Number
7	IO_L27P_7/VREF_7	H5
7	IO_L27N_7	H6
7	IO_L25P_7	J7
7	IO_L25N_7	J8
7	IO_L24P_7	G1
7	IO_L24N_7	F1
7	IO_L22P_7	G2
7	IO_L22N_7	G3
7	IO_L21P_7/VREF_7	F2
7	IO_L21N_7	F3
7	IO_L19P_7	G5
7	IO_L19N_7	G6
7	IO_L06P_7	F4
7	IO_L06N_7	F5
7	IO_L04P_7	E1
7	IO_L04N_7	E2
7	IO_L03P_7/VREF_7	D1
7	IO_L03N_7	C1
7	IO_L02P_7/VRN_7	E3
7	IO_L02N_7/VRP_7	E4
7	IO_L01P_7	D2
7	IO_L01N_7	D3
0	VCCO_0	K13
0	VCCO_0	K12
0	VCCO_0	K11
0	VCCO_0	J11
0	VCCO_0	J10
0	VCCO_0	G12
0	VCCO_0	D7
0	VCCO_0	C12
1	VCCO_1	K17
1	VCCO_1	K16
1	VCCO_1	K15
1	VCCO_1	J18
1	VCCO_1	J17

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
7	IO_L75N_7	R28	
7	IO_L74P_7	R26	
7	IO_L74N_7	P26	
7	IO_L73P_7	N31	
7	IO_L73N_7	P31	
7	IO_L72P_7	N30	
7	IO_L72N_7	P30	
7	IO_L71P_7	R25	
7	IO_L71N_7	P25	
7	IO_L70P_7	L34	
7	IO_L70N_7	M34	
7	IO_L69P_7/VREF_7	P29	
7	IO_L69N_7	N29	
7	IO_L68P_7	P27	
7	IO_L68N_7	N27	
7	IO_L67P_7	L32	
7	IO_L67N_7	M32	
7	IO_L54P_7	L31	
7	IO_L54N_7	M31	
7	IO_L53P_7	K29	
7	IO_L53N_7	L30	
7	IO_L52P_7	L33	
7	IO_L52N_7	M33	
7	IO_L51P_7/VREF_7	M29	
7	IO_L51N_7	L29	
7	IO_L50P_7	M28	
7	IO_L50N_7	N28	
7	IO_L49P_7	K30	
7	IO_L49N_7	K31	
7	IO_L48P_7	H32	
7	IO_L48N_7	J32	
7	IO_L47P_7	N26	
7	IO_L47N_7	M26	
7	IO_L46P_7	J33	
7	IO_L46N_7	K33	
7	IO_L45P_7/VREF_7	H33	

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
5	VCCO_5	AP19	
5	VCCO_5	AL28	
5	VCCO_5	AK20	
5	VCCO_5	AD23	
5	VCCO_5	AD22	
5	VCCO_5	AD21	
5	VCCO_5	AD20	
5	VCCO_5	AC22	
5	VCCO_5	AC21	
5	VCCO_5	AC20	
5	VCCO_5	AC19	
5	VCCO_5	AC18	
6	VCCO_6	AH31	
6	VCCO_6	AE34	
6	VCCO_6	AC24	
6	VCCO_6	AB24	
6	VCCO_6	AB23	
6	VCCO_6	AA24	
6	VCCO_6	AA23	
6	VCCO_6	Y30	
6	VCCO_6	Y24	
6	VCCO_6	Y23	
6	VCCO_6	W34	
6	VCCO_6	W23	
6	VCCO_6	V23	
7	VCCO_7	U23	
7	VCCO_7	T34	
7	VCCO_7	T23	
7	VCCO_7	R30	
7	VCCO_7	R24	
7	VCCO_7	R23	
7	VCCO_7	P24	
7	VCCO_7	P23	
7	VCCO_7	N24	
7	VCCO_7	N23	
7	VCCO_7	M24	

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
2	IO_L33P_2/VREF_2	J4	NC	
2	IO_L34N_2	K2	NC	
2	IO_L34P_2	J2	NC	
2	IO_L35N_2	P12	NC	
2	IO_L35P_2	R12	NC	
2	IO_L36N_2	M6	NC	
2	IO_L36P_2	L6	NC	
2	IO_L43N_2	L3		
2	IO_L43P_2	K3		
2	IO_L44N_2	N9		
2	IO_L44P_2	P9		
2	IO_L45N_2	M4		
2	IO_L45P_2/VREF_2	L4		
2	IO_L46N_2	L1		
2	IO_L46P_2	K1		
2	IO_L47N_2	P10		
2	IO_L47P_2	R10		
2	IO_L48N_2	N5		
2	IO_L48P_2	M5		
2	IO_L49N_2	N3		
2	IO_L49P_2	M3		
2	IO_L50N_2	N8		
2	IO_L50P_2	P8		
2	IO_L51N_2	T11		
2	IO_L51P_2/VREF_2	R11		
2	IO_L52N_2	N2		
2	IO_L52P_2	M2		
2	IO_L53N_2	T12		
2	IO_L53P_2	U12		
2	IO_L54N_2	P6		
2	IO_L54P_2	N6		
2	IO_L55N_2	N1		
2	IO_L55P_2	M1		
2	IO_L56N_2	R8		
2	IO_L56P_2	T8		
2	IO_L57N_2	R7		

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
2	IO_L81P_2/VREF_2	U5		
2	IO_L82N_2	V2		
2	IO_L82P_2	U2		
2	IO_L83N_2	V8		
2	IO_L83P_2	W8		
2	IO_L84N_2	W7		
2	IO_L84P_2	V7		
2	IO_L91N_2	W1		
2	IO_L91P_2	V1		
2	IO_L92N_2	Y11		
2	IO_L92P_2	Y12		
2	IO_L93N_2	W4		
2	IO_L93P_2/VREF_2	V4		
2	IO_L94N_2	W2		
2	IO_L94P_2	W3		
2	IO_L95N_2	Y8		
2	IO_L95P_2	Y9		
2	IO_L96N_2	W5		
2	IO_L96P_2	W6		
3	IO_L96N_3	AB8		
3	IO_L96P_3	AA8		
3	IO_L95N_3	Y3		
3	IO_L95P_3	AA3		
3	IO_L94N_3	Y6		
3	IO_L94P_3	AA6		
3	IO_L93N_3/VREF_3	AB9		
3	IO_L93P_3	AA9		
3	IO_L92N_3	AA1		
3	IO_L92P_3	AB1		
3	IO_L91N_3	Y5		
3	IO_L91P_3	AA5		
3	IO_L84N_3	AB10		
3	IO_L84P_3	AA10		
3	IO_L83N_3	AA2		
3	IO_L83P_3	AB2		

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
5	IO_L25N_5	AV33		
5	IO_L25P_5	AV32		
5	IO_L24N_5	AR31		
5	IO_L24P_5	AR30		
5	IO_L23N_5	AL27		
5	IO_L23P_5	AL28		
5	IO_L22N_5	AW34		
5	IO_L22P_5	AW33		
5	IO_L21N_5/VREF_5	AN30		
5	IO_L21P_5	AP30		
5	IO_L20N_5	AM28		
5	IO_L20P_5	AM29		
5	IO_L19N_5	AU33		
5	IO_L19P_5	AU32		
5	IO_L12N_5	AT33	NC	
5	IO_L12P_5	AT32	NC	
5	IO_L11N_5	AK27	NC	
5	IO_L11P_5	AK28	NC	
5	IO_L10N_5	AV35	NC	
5	IO_L10P_5	AV34	NC	
5	IO_L09N_5/VREF_5	AP32	NC	
5	IO_L09P_5	AP31	NC	
5	IO_L08N_5	AL29	NC	
5	IO_L08P_5	AK29	NC	
5	IO_L07N_5	AW36	NC	
5	IO_L07P_5	AW35	NC	
5	IO_L06N_5	AR33		
5	IO_L06P_5	AR32		
5	IO_L05N_5/VRP_5	AM30		
5	IO_L05P_5/VRN_5	AL30		
5	IO_L04N_5	AU35		
5	IO_L04P_5/VREF_5	AU34		
5	IO_L03N_5/D4/ALT_VRP_5	AR34		
5	IO_L03P_5/D5/ALT_VRN_5	AT34		
5	IO_L02N_5/D6	AN31		
5	IO_L02P_5/D7	AM31		

BF957 Flip-Chip BGA Package

As shown in [Table 14](#), XC2V2000, XC2V3000, XC2V4000, and XC2V6000 Virtex-II devices are available in the BF957 package. Pins in each of these devices are the same, except for the pin differences in the XC2V2000 device shown in the No Connect column. Following this table are the [BF957 Flip-Chip BGA Package Specifications \(1.27mm pitch\)](#).

Table 14: BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000

Bank	Pin Description	Pin Number	No Connect in XC2V2000
0	IO_L01N_0	H23	
0	IO_L01P_0	H22	
0	IO_L02N_0	G24	
0	IO_L02P_0	E25	
0	IO_L03N_0/VRP_0	B29	
0	IO_L03P_0/VRN_0	C27	
0	IO_L04N_0/VREF_0	F24	
0	IO_L04P_0	F23	
0	IO_L05N_0	D26	
0	IO_L05P_0	D25	
0	IO_L06N_0	A28	
0	IO_L06P_0	A27	
0	IO_L19N_0	J22	
0	IO_L19P_0	J21	
0	IO_L20N_0	G23	
0	IO_L20P_0	G22	
0	IO_L21N_0	B27	
0	IO_L21P_0/VREF_0	B26	
0	IO_L22N_0	K20	
0	IO_L22P_0	K19	
0	IO_L23N_0	C26	
0	IO_L23P_0	C24	
0	IO_L24N_0	D24	
0	IO_L24P_0	D23	
0	IO_L25N_0	E24	NC
0	IO_L25P_0	E23	NC
0	IO_L26N_0	G21	NC
0	IO_L26P_0	G20	NC
0	IO_L27N_0	A26	NC
0	IO_L27P_0/VREF_0	A25	NC
0	IO_L29N_0	H21	NC
0	IO_L29P_0	H20	NC
0	IO_L30N_0	B25	NC
0	IO_L30P_0	B23	NC